

# SMP-MAX/SMP-MAX Evolution (EVO) 50-Ohm Board-to-Board and Board-to-Filter RF Connectors >

Lowering the risk of assembly error and simplifying design requirements, SMP-MAX and SMP-MAX EVO 50-Ohm Board-to-Board and Board-to-Filter RF Connectors use patented technology to increase mechanical tolerances

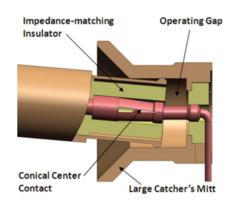
### FEATURES AND ADVANTAGES: SMP-MAX

Impedance-matching insulator optimized in case of operating gaps if the adapter is not fully engaged in the receptacle

Ensures signal integrity even with gaps up to 2.00mm (SMP-MAX) and 2.40mm (SMP-MAX EVO) with no significant changes to VSWR

### Board-mount receptacle with a conical center contact

Prevents additional stress due to misalignment. Increases reliability



Patented technology accommodates significant misalignment variation and increases board-to-board mechanical tolerances

Eliminates the risk of assembly errors during manufacturing. Reduces manufacturing time and costs by simplifying design efforts

Funnel-shape (catcher's mitt) design in PCB receptacle with up to 3 degrees of angular misalignment allowance

Minimizes stubbing of mating pairs. Facilitates blind mating



SMP-MAX 50-Ohm Board-to-Board Connectors



# SMP-MAX/SMP-MAX Evolution (EVO) 50-Ohm Board-to-Board and Board-to-Filter RF Connectors >

### **FEATURES AND ADVANTAGES**

Features	Advantages
Wide operating frequency range of DC to 10 GHz	Meets wireless communications' required range of 800 MHz to 6 GHz
Optional adapter lengths of 6.20 to 67.45mm	Accommodates a wide range of board-to-board distances
Subminiature connector	Provides space savings and is lightweight for smaller applications
Rugged construction @ 4 GHz	Delivers 100-minimum mating life cycle
Power handling SMP-MAX:  • >300W at 2.7 GHz and 25°C  • >200W at 2.7 GHz and 85°C SMP-MAX EVO:  • 30W @ 125°C average  • 150W @ 125°C peak	Provides ideal performance for RF amplifiers
Push-on and snap coupling options	Offers two levels of retention for design flexibility: high-retention snap for sturdy connections and low-retention push on for applications involving swapping out boards
Through-hole and surface-mount options available	Provides flexibility to meet application requirements

### **SMP-MAX EVOLUTION (EVO AND EVO 5)**

Bullet outer contact developed from deep-drawn technology

Eases blind mating. Prevents damage during mating



SMP-Max Plug



SMP-Max EVO Plug

## Machined contact via deep-drawn process

Produces larger quantities for faster mass production. Deliver cost efficiencies for bulk orders

### Outer contact available with gold or tri-metal plating

Has tri-metal plating provides a cost-saving option by eliminating the need for soldering



Tri-Metal Deep-Drawn Body

### The SMP-MAX EVO 5 Bullet has a stamped contact with an injection insulator

An ideal option for cost-effective, high-production programs

Features	Advantages
Frequency up to 10 GHz (Note: dependent upon customer's working frequency)	Meets needs of market trends, such as 5G capabilities and beyond. Provides economical RF connectivity without compromising performance
PCB type body machined brass to black PA	Alternative for less power handling
Less machined brass material used	Reduced metal as well as plating composition



# SMP-MAX/SMP-MAX Evolution (EVO) 50-Ohm Board-to-Board and Board-to-Filter RF Connectors >

### MARKETS AND APPLICATIONS

### **Telecommunications/Networking**

Base Stations (Macro RRH/AAU/Antenna/Filter) Radio Heads System Modules Radio Modules Small Cells Repeaters 5G Massive MIMO





Radio Heads

5G infrastructure

### **SPECIFICATIONS**

#### **Reference Information**

Packaging: Tray, Bulk, Single Bag, Tape and Reel

Designed In: Millimeters

RoHS: Yes

Halogen Free: Yes

#### **Mechanical**

Center Contact Retention Force: > 7N

Force to Engage/Disengage:

Engagement Force (Typical)

Detent (Snap-On) — 45N

Smooth Bore — 14N

Disengagement Force (Typical)

Detent (Snap-On) — 9 to 45N

Smooth Bore (Slide-On) — 9N

Connector Durability (min.): 100 Cycles

#### **Electrical**

Nominal Impedance: 50 Ohms

Voltage (max.): 330V rms

Frequency Rating: DC to 10 GHz  $\,$ 

Power (50 Ohm Design):

>300W at 2.7 GHz and 25°C

>200W at 2.7 GHz and 85°C

EVO 30W @ 125°C average, 150W @ 125°C

peak VSWR (max.):

See individual SD or below typical

 $1.20-\!\!\!-$  DC to 3 GHz

1.35 — 3 to 6 GHz

Insertion Loss (max.):

See individual SD or below typical

0.12 — DC to 3 GHz

0.25 — 3 to 6 GHz

### **Physical**

Housing: Brass/Beryllium Copper

Male Center Contact: Brass

Female Center Contact: Beryllium Copper

Plating:

Body and Contact — Gold Over High-

Phosphorous Nickel Over Copper

Insulator: PEEK or Teflon

Operating Temperature: -55 to +165°C